Surface Mounting Chip LED

Side View Type

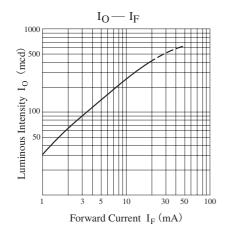
■Absolute Maximum Ratings (T_a=25±3°C)

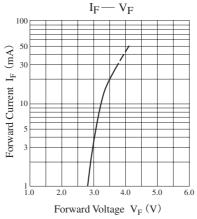
Lighting Color	P(mW)	I _{FDC} (mA)	I _{FP} (mA)	$V_R(V)$	T _{opr} (°C)	T _{stg} (°C)
White	98	25	60	5	$-30 \sim +80$	−40~+85

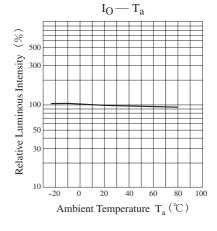
Unit: mm 0.8 3.1±0.1 0.8 0.68 0.98 4.7 0.98 0.98 1: Anode 2: Cathode

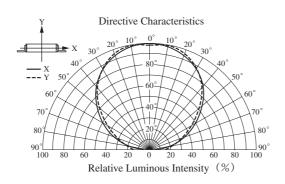
■Main Specification (T_a=25°C)

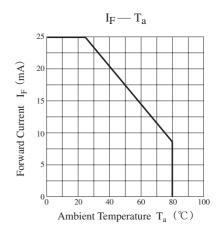
Item	Symbol	Condition	Tun	Limit		Unit
item		Condition	Тур	Min	Max	Offic
Forward Voltage	$V_{\rm F}$	$I_F = 10 \text{mA DC}$	3.2		3.9	V
Reverse Leakage Current	IR	$V_R = 5V$			10	μ A
Luminous Intensity	Io	$I_F = 10 \text{mA DC}$	260	210	290	mcd
Lummous intensity	10	$I_F = 20 \text{mA DC}$	(416)	(336)	(464)	
Charactic	X	$I_F = 10 \text{ mA DC}$	_	0.250	0.280	_
Chromatic coordinates	у	$I_F = 10 \text{ mA DC}$	_	0.220	0.285	_











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